Electronic Pate	nt App	lication Fee	Transm	ittal			
Application Number:	105	10598469					
Filing Date:	17-	17-May-2007					
Title of Invention:	ми	MULTILAYER SUBSTRATE MANUFACTURING METHOD					
First Named Inventor/Applicant Name:	Tak	Takeshi Nakamura					
Filer:	San	Samuel Borodach/Paula Romeo					
Attorney Docket Number:	142	14225-112US1 F1040898US00					
Filed as Large Entity	•						
U.S. National Stage under 35 USC 371 Fili	ing Fee:	;					
Description		Fee Code	Quantity	Amount	Sub-Total in USD(\$)		
Basic Filing:							
Pages:							
Claims:							
Miscellaneous-Filing:							
Petition:							
Patent-Appeals-and-Interference:							
Post-Allowance-and-Post-Issuance:							

Publ. Fee- early, voluntary, or normal

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Extension-of-Time:				
Miscellaneous:				
	Total in USD (\$)			1810